8-stage shift-and-store register Rev. 11 — 29 August 2013

Product data sheet

1. **General description**

The HEF4094B is an 8-stage serial shift register. It has a storage latch associated with each stage for strobing data from the serial input to parallel buffered 3-state outputs QP0 to QP7. The parallel outputs may be connected directly to common bus lines. Data is shifted on positive-going clock transitions. The data in each shift register stage is transferred to the storage register when the strobe (STR) input is HIGH. Data in the storage register appears at the outputs whenever the output enable (OE) signal is HIGH.

Two serial outputs (QS1 and QS2) are available for cascading a number of HEF4094B devices. Serial data is available at QS1 on positive-going clock edges to allow high-speed operation in cascaded systems with a fast clock rise time. The same serial data is available at QS2 on the next negative going clock edge. This is used for cascading HEF4094B devices when the clock has a slow rise time.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD}, V_{SS}, or another input.

Features and benefits 2.

	Fully	static	operation
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- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40 °C to +85 °C and -40 °C to +125 °C
- Complies with JEDEC standard JESD 13-B

3. Ordering information

Table 1. **Ordering information**

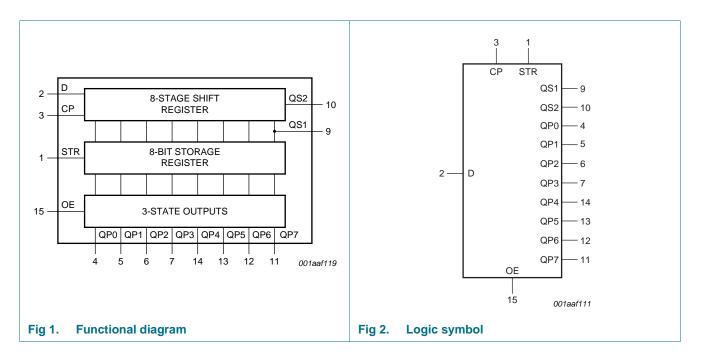
All types operate from $-40 \degree$ C to $+125 \degree$ C.

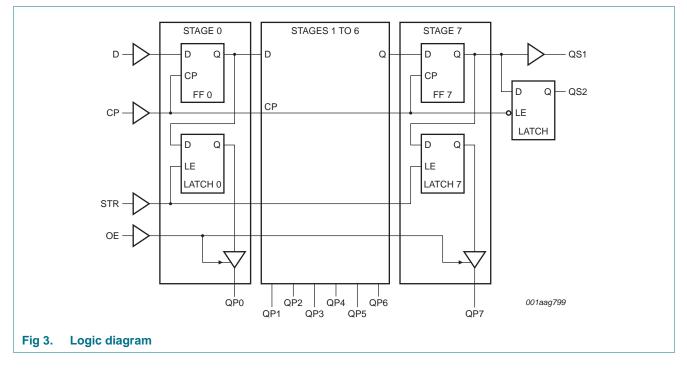
Type number	Package								
	Name	Description	Version						
HEF4094BP	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4						
HEF4094BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1						
HEF4094BTS	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1						
HEF4094BTT	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1						



8-stage shift-and-store register

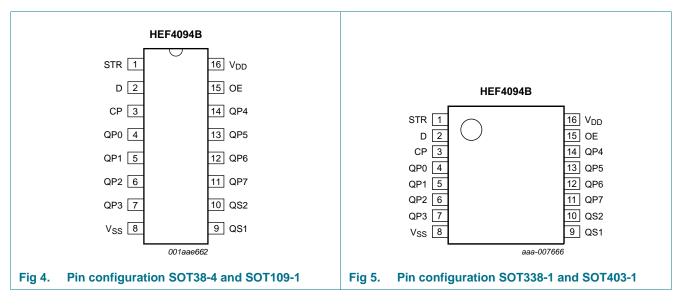
4. Functional diagram





5. Pinning information

5.1 Pinning



5.2 Pin description

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Table 2. Pin	description	
Symbol	Pin	Description
STR	1	strobe input
D	2	data input
CP	3	clock input
QP0 to QP7	4, 5, 6, 7, 14, 13, 12, 11	parallel output
V _{SS}	8	ground supply voltage
QS1	9	serial output
QS2	10	serial output
OE	15	output enable input
V _{DD}	16	supply voltage

6. Functional description

Table 3. Function table^[1]

Inputs	nputs				Parallel outputs		Serial outputs	
СР	OE	STR	D	QP0	QPn	QS1	QS2	
\uparrow	L	Х	Х	Z	Z	Q6S	NC	
\downarrow	L	Х	Х	Z	Z	NC	Q7S	
\uparrow	Н	L	Х	NC	NC	Q6S	NC	
\uparrow	Н	Н	L	L	QPn –1	Q6S	NC	
\uparrow	Н	Н	Н	Н	QPn –1	Q6S	NC	
\downarrow	Н	Н	Н	NC	NC	NC	Q7S	

[1] At the positive clock edge, the information in the 7th register stage is transferred to the 8th register stage and the QSn outputs.

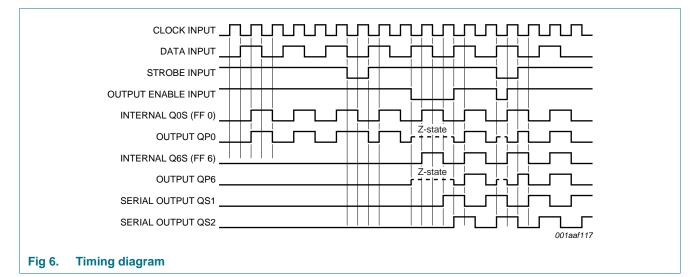
H = HIGH voltage level; L = LOW voltage level; X = don't care;

 \uparrow = positive-going transition; \downarrow = negative-going transition;

Z = HIGH-impedance OFF-state; NC = no change;

Q6S = the data in register stage 6 before the LOW to HIGH clock transition;

Q7S = the data in register stage 7 before the HIGH to LOW clock transition.



7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to V_{SS} = 0 V (ground).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DD}	supply voltage		-0.5	+18	V
I _{IK}	input clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm DD}$ + 0.5 V	-	±10	mA
VI	input voltage		-0.5	$V_{DD} + 0.5$	V
I _{OK}	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm DD}$ + 0.5 V	-	±10	mA
I _{I/O}	input/output current		-	±10	mA
I _{DD}	supply current		-	50	mA
T _{stg}	storage temperature		-65	+150	°C
T _{amb}	ambient temperature		-40	+125	°C
P _{tot}	total power dissipation	DIP16	<u>[1]</u> _	750	mW
		SO16, SSOP16 and TSSOP16	[2] _	500	mW
Р	power dissipation	per output	-	100	mW

[1] For DIP16 packages: above T_{amb} = 70 °C, P_{tot} derates linearly with 12 mW/K.

For SO16 package: P_{tot} derates linearly with 8 mW/K above 70 °C.
 For (T)SSOP16 package: P_{tot} derates linearly with 5.5 mW/K above 60 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{DD}	supply voltage		3	-	15	V
VI	input voltage		0	-	V_{DD}	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{DD} = 5 V$	-	-	3.75	μs/V
		V _{DD} = 10 V	-	-	0.5	μs/V
		V _{DD} = 15 V	-	-	0.08	μs/V

9. Static characteristics

Table 6. Static characteristics

 $V_{SS} = 0$ V; $V_l = V_{SS}$ or V_{DD} ; unless otherwise specified.

Symbol	Parameter	Conditions	V _{DD}	T _{amb} =	–40 °C	T _{amb} =	+25 °C	T _{amb} =	+85 °C	T _{amb} = ·	+125 °C	Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
V _{IH}	HIGH-level	I _O < 1 μA	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V
	input voltage		10 V	7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	11.0	-	V
V _{IL}	LOW-level	$ I_0 < 1 \ \mu A$	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
	input voltage		10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
V _{OH}	HIGH-level output voltage	$ I_0 < 1 \ \mu A$	5 V	4.95	-	4.95	-	4.95	-	4.95	-	V
			10 V	9.95	-	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	14.95	-	V
V _{OL} LOW-level	$ I_0 < 1 \ \mu A$	5 V	-	0.05	-	0.05	-	0.05	-	0.05	V	
	output voltage		10 V	-	0.05	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	-	0.05	V
I _{OH}	HIGH-level	$V_{0} = 2.5 V$	5 V	-	-1.7	-	-1.4	-	-1.1	-	-1.1	mA
	output current	$V_{O} = 4.6 V$	5 V	-	-0.64	-	-0.5	-	-0.36	-	-0.36	mA
		V _O = 9.5 V	10 V	-	-1.6	-	-1.3	-	-0.9	-	-0.9	mA
		V _O = 13.5 V	15 V	-	-4.2	-	-3.4	-	-2.4	-	-2.4	mA
I _{OL}	LOW-level	$V_{O} = 0.4 V$	5 V	0.64	-	0.5	-	0.36	-	0.36	-	mA
	output current	$V_{O} = 0.5 V$	10 V	1.6	-	1.3	-	0.9	-	0.9	-	mA
		V _O = 1.5 V	15 V	4.2	-	3.4	-	2.4	-	2.4	-	mA
I _{OZ}	OFF-state output current	QPn output is HIGH; V _O = 15 V	15 V	-	0.4	-	0.4	-	12	-	12	μΑ
l _l	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	-	±1.0	μΑ
I _{DD}	supply current	all valid input	5 V	-	5	-	5	-	150	-	150	μA
		combinations; $L_{2} = 0.0$	10 V	-	10	-	10	-	300	-	300	μA
		I _O = 0 A	15 V	-	20	-	20	-	600	-	600	μA
CI	input capacitance			-	-	-	7.5	-	-	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

 $V_{SS} = 0 V$; $T_{amb} = 25$ °C; for test circuit see <u>Figure 11</u>; unless otherwise specified.

Symbol	Parameter	Conditions	V_{DD}	Extrapolation formula	Min	Тур	Max	Unit
t _{PHL}	HIGH to LOW	CP to QS1;	5 V	[1] 108 ns + (0.55 ns/pF)C _L	-	135	270	ns
	propagation delay	see Figure 7	10 V	54 ns + (0.23 ns/pF)C _L	-	65	130	ns
			15 V	42 ns + (0.16 ns/pF)C _L	-	50	100	ns
		CP to QS2;	5 V	78 ns + (0.55 ns/pF)C _L	-	105	210	ns
		see Figure 7	10 V	39 ns + (0.23 ns/pF)C _L	-	50	100	ns
			15 V	32 ns + (0.16 ns/pF)C _L	-	40	80	ns
		CP to QPn;	5 V	138 ns + (0.55 ns/pF)C _L	-	165	330	ns
		see Figure 7	10 V	64 ns + (0.23 ns/pF)C _L	-	75	150	ns
			15 V	47 ns + (0.16 ns/pF)C _L	-	55	110	ns
		STR to QPn;	5 V	83 ns + (0.55 ns/pF)C _L	-	110	220	ns
		see <u>Figure 8</u>	10 V	39 ns + (0.23 ns/pF)C _L	-	50	100	ns
			15 V	27 ns + (0.16 ns/pF)C _L	-	35	70	ns
t _{PLH}	LOW to HIGH	CP to QS1;	5 V	[1] 78 ns + (0.55 ns/pF)C _L	-	105	210	ns
	propagation delay,	see Figure 7	10 V	39 ns + (0.23 ns/pF)C _L	-	50	100	ns
			15 V	32 ns + (0.16 ns/pF)C _L	-	40	80	ns
		CP to QS2;	5 V	78 ns + (0.55 ns/pF)C _L	-	105	210	ns
		see Figure 7	10 V	39 ns + (0.23 ns/pF)C _L	-	50	100	ns
			15 V	32 ns + (0.16 ns/pF)C _L	-	40	80	ns
		CP to QPn; see <u>Figure 7</u>	5 V	123 ns + (0.55 ns/pF)C _L	-	150	300	ns
			10 V	59 ns + (0.23 ns/pF)C _L	-	70	140	ns
			15 V	47 ns + (0.16 ns/pF)C _L	-	55	110	ns
		STR to QPn; see <u>Figure 8</u>	5 V	73 ns + (0.55 ns/pF)C _L	-	100	200	ns
			10 V	34 ns + (0.23 ns/pF)C _L	-	45	90	ns
			15 V	27 ns + (0.16 ns/pF)C _L	-	35	70	ns
t _t	transition time		5 V	10 ns + (1.00 ns/pF)C _L	-	60	120	ns
			10 V	9 ns + (0.42 ns/pF)C _L	-	30	60	ns
			15 V	6 ns + (0.28 ns/pF)C _L	-	20	40	ns
t _{PZH}	OFF-state to HIGH	OE to QPn;	5 V		-	40	80	ns
	propagation delay	see Figure 9	10 V		-	25	50	ns
			15 V		-	20	40	ns
t _{PZL}	OFF-state to LOW	OE to QPn;	5 V		-	40	80	ns
	propagation delay	see Figure 9	10 V		-	25	50	ns
			15 V		-	20	40	ns
t _{PHZ}	HIGH to OFF-state	OE to QPn;	5 V		-	75	150	ns
	propagation delay	see <u>Figure 9</u>	10 V		-	40	80	ns
			15 V		-	30	60	ns

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8-stage shift-and-store register

Symbol	Parameter	Conditions	V _{DD}	Extrapolation formula	Min	Тур	Max	Unit
t _{PLZ}	LOW to OFF-state	OE to QPn;	5 V		-	80	160	ns
	propagation delay	see Figure 9	10 V		-	40	80	ns
			15 V		-	30	60	ns
t _{su}	set-up time	D to CP;	5 V		60	30	-	ns
		see <u>Figure 10</u>	10 V		20	10	-	ns
			15 V		15	5	-	ns
t _h	hold time	D to CP; see <u>Figure 10</u>	5 V		+5	-15	-	ns
			10 V		20	5	-	ns
			15 V		20	5	-	ns
t _W	pulse width	minimum LOW clock pulse; see <u>Figure 7</u>	5 V		60	30	-	ns
			10 V		30	15	-	ns
			15 V		24	12	-	ns
		minimum HIGH	5 V		40	20	-	ns
		strobe pulse;	10 V		30	15	-	ns
		see <u>Figure 8</u>	15 V		24	12	-	ns
f _{max}	maximum frequency	see Figure 7	5 V		5	10	-	MHz
			10 V		11	22	-	MHz
			15 V		14	28	-	MHz

Table 7. Dynamic characteristics ... continued

[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C_L in pF).

Dynamic power dissipation Table 8.

 $V_{SS} = 0 V; t_r = t_f \le 20 ns; T_{amb} = 25$ °C.

Symbol	Parameter	V_{DD}	Typical formula for P_D (μ W)	where:
P _D dynamic power dissipation	5 V	$P_D = 2100 \times f_i + \Sigma(f_o \times C_L) \times V_DD{}^2$	$f_i = input frequency in MHz,$	
	dissipation	10 V	$P_D = 9700 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2$	$f_o = output frequency in MHz,$
		15 V	$P_{D} = 26000 \times f_{i} + \Sigma (f_{o} \times C_{L}) \times V_{DD}^{2}$	C_L = output load capacitance in pF,
				V_{DD} = supply voltage in V,
				$\Sigma(f_o \times C_L)$ = sum of the outputs.

8-stage shift-and-store register

11. Waveforms

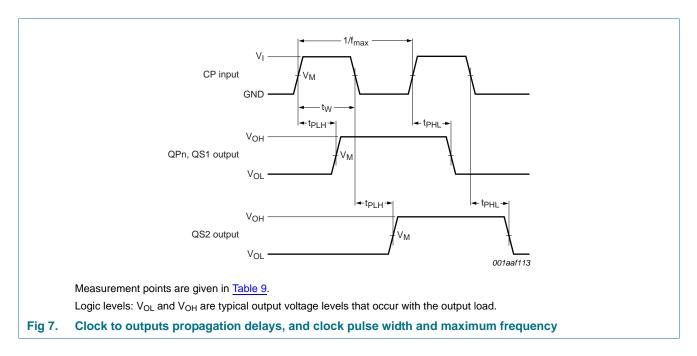
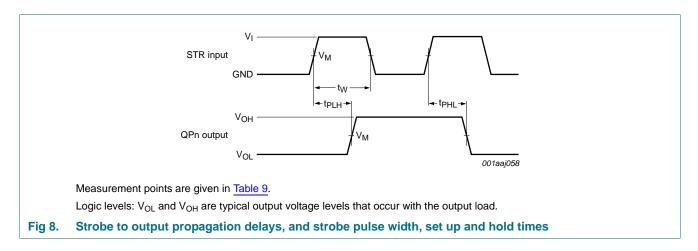


Table 9. Measurement points

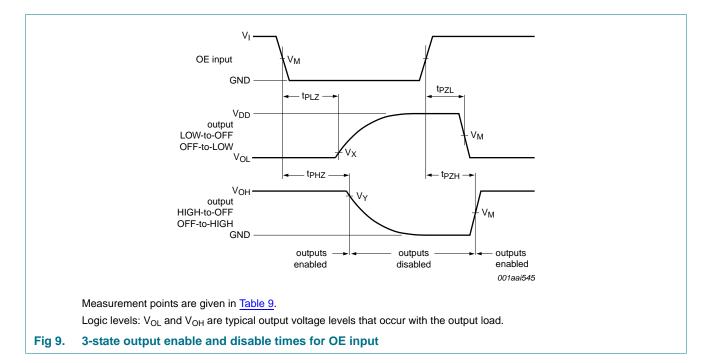
Supply voltage	Input	Output				
V _{DD}	V _M	V _M	V _X	V _Y		
5 V to 15 V	0.5V _{DD}	0.5V _{DD}	0.1V _{DD}	0.9V _{DD}		

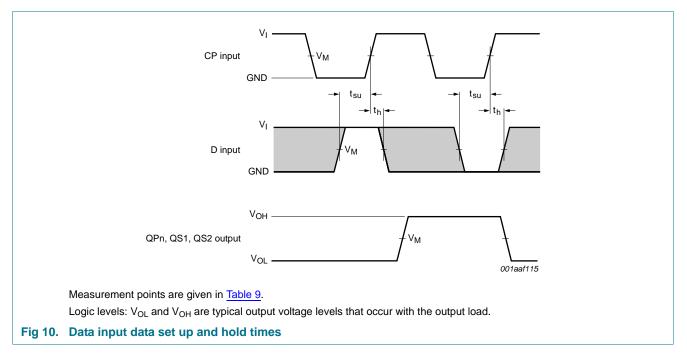


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8-stage shift-and-store register





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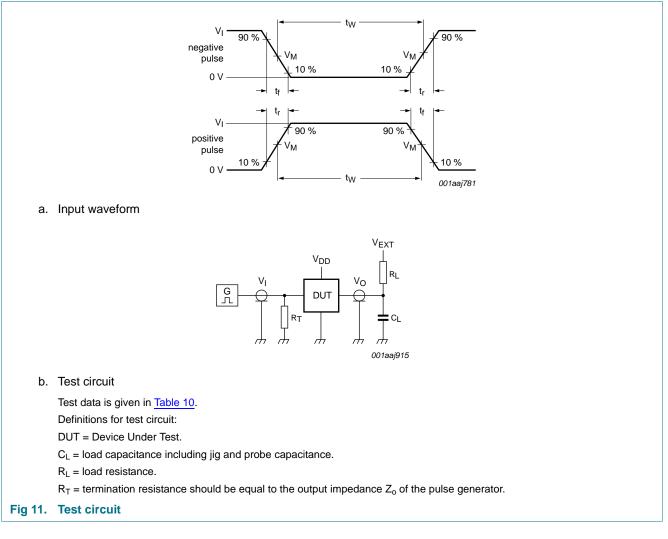


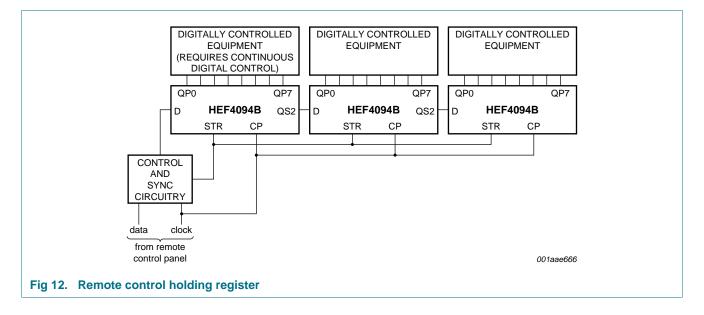
Table 10. Test data

Supply voltage	Input		V _{EXT}		Load		
V _{DD}	VI	t _r , t _f	t _{PHL} , t _{PLH}	t _{PHZ} , t _{PZH}	t _{PLZ} , t _{PZL}	CL	RL
5 V to 15 V	$V_{\text{SS}} \text{ or } V_{\text{DD}}$	\leq 20 ns	open	V _{SS}	V _{DD}	50 pF	1 kΩ

12. Application information

Some examples of applications for the HEF4094B are:

- Serial-to-parallel data conversion
- Remote control holding register



HEF4094B

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13. Package outline

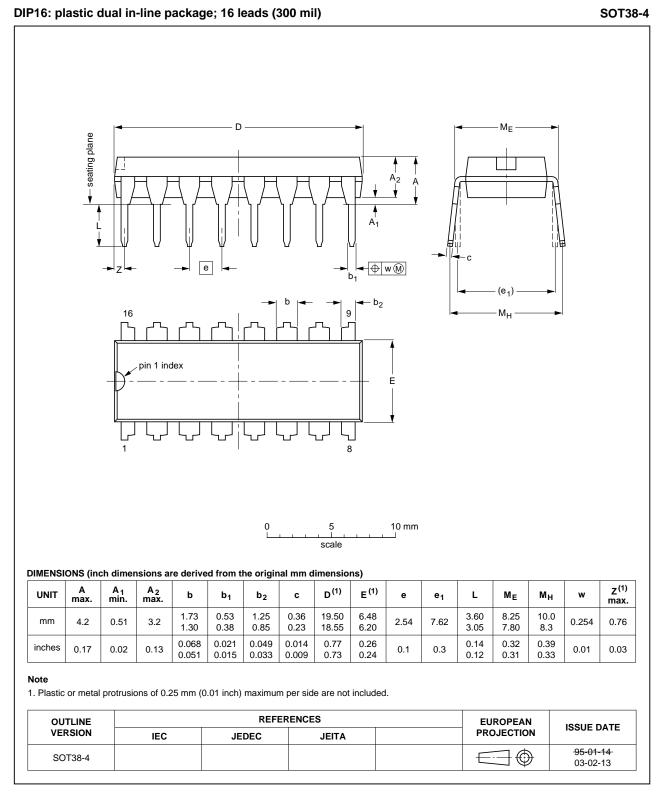


Fig 13. Package outline SOT38-4 (DIP16)

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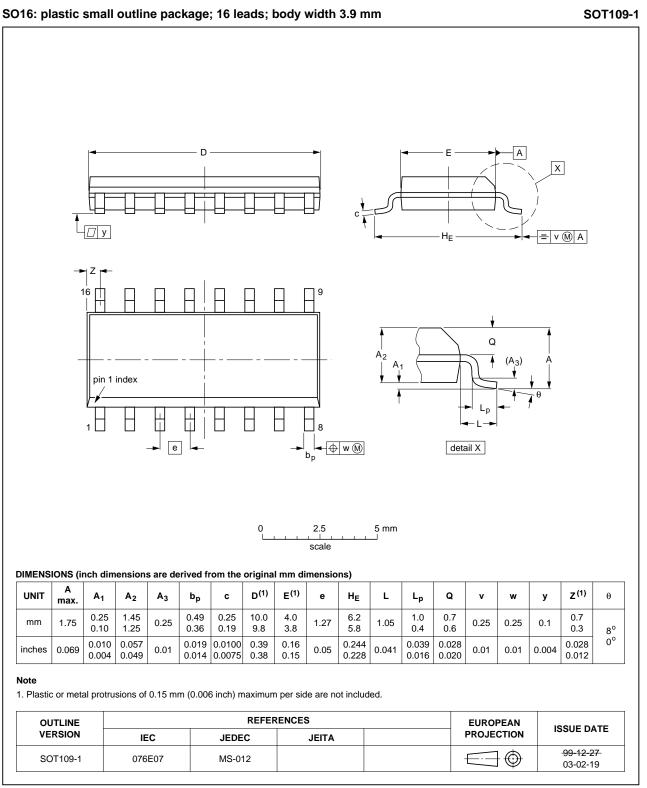


Fig 14. Package outline SOT109-1 (SO16)

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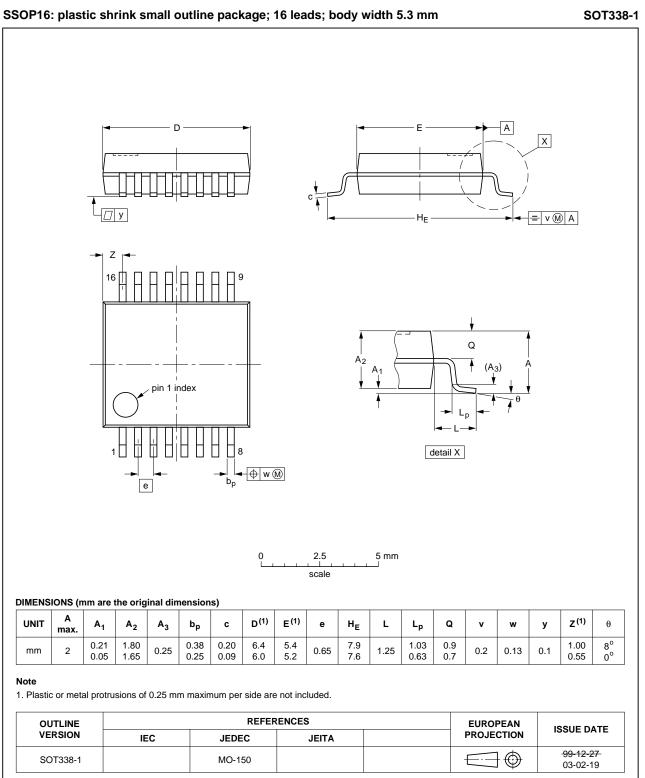


Fig 15. Package outline SOT338-1 (SSOP16)

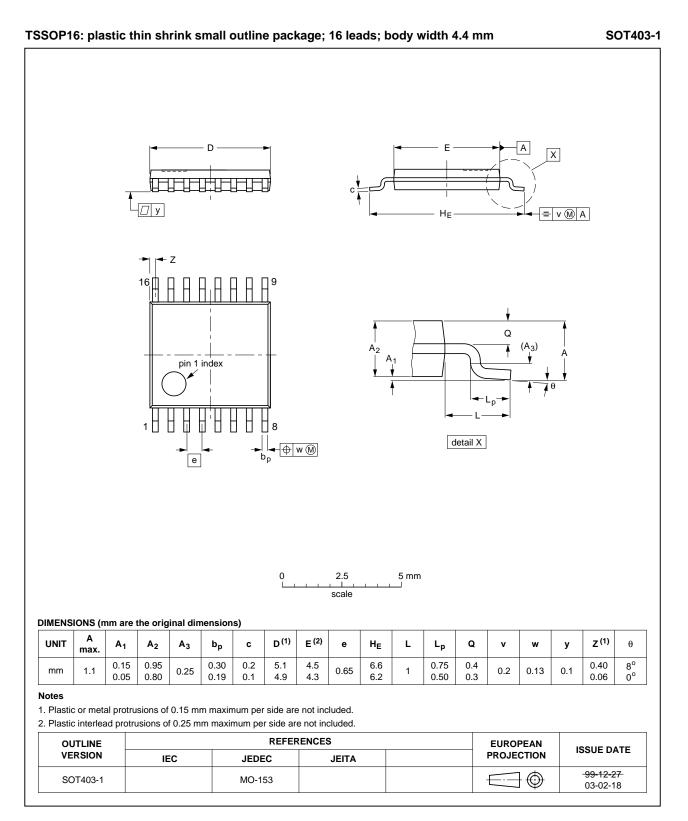


Fig 16. Package outline SOT403-1 (TSSOP16)

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14. Revision history

Table 11. Revision his	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4094B v.11	20130829	Product data sheet	-	HEF4094B v.10
Modifications:	• <u>Table 4</u> : Tab	ble note corrected (errata).		
HEF4094B v.10	20130625	Product data sheet	-	HEF4094B v.9
Modifications:	 added type 	number HEF4094BTT.		
HEF4094B v.9	20111116	Product data sheet	-	HEF4094B v.8
Modifications:	 <u>Table 6</u>: I_{OH} 	minimum values changed to	o maximum	
HEF4094B v.8	20100402	Product data sheet	-	HEF4094B v.7
HEF4094B v.7	20091216	Product data sheet	-	HEF4094B v.6
HEF4094B v.6	20091103	Product data sheet	-	HEF4094B v.5
HEF4094B v.5	20090728	Product data sheet	-	HEF4094B v.4
HEF4094B v.4	20081030	Product data sheet	-	HEF4094B_CNV v.3
HEF4094B_CNV v.3	19950101	Product specification	-	HEF4094B_CNV v.2
HEF4094B_CNV v.2	19950101	Product specification	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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